

# FDMC86260 N-Channel Power Trench<sup>®</sup> MOSFET

## **FDMC86260** N-Channel Power Trench<sup>®</sup> MOSFET 150 V, 16 A, 34 m $\Omega$

### Features

- Max  $r_{DS(on)}$  = 34 m $\Omega$  at V<sub>GS</sub> = 10 V, I<sub>D</sub> = 5.4 A
- Max  $r_{DS(on)}$  = 44 m $\Omega$  at V<sub>GS</sub> = 6 V, I<sub>D</sub> = 4.8 A
- High performance technology for extremely low r<sub>DS(on)</sub>
- 100% UIL Tested
- Termination is Lead-free
- RoHS Compliant

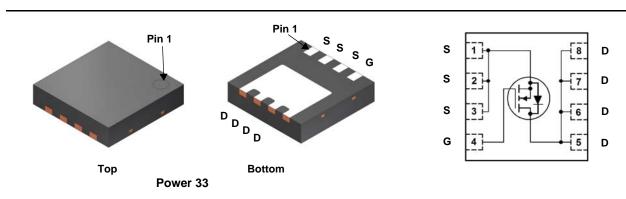


### **General Description**

This N-Channel MOSFET is produced using Fairchild Semiconductor's advanced Power Trench<sup>®</sup> process that has been especially tailored to minimize the on-state resistance and yet maintain superior switching performance.

### Application

DC-DC Conversion



### MOSFET Maximum Ratings T<sub>A</sub> = 25 °C unless otherwise noted

Symbol	Parameter			Ratings	Units
V <sub>DS</sub>	Drain to Source Voltage			150	V
V <sub>GS</sub>	Gate to Source Voltage			±20	V
	Drain Current -Continuous	T <sub>C</sub> = 25 °C		16	
I <sub>D</sub>	-Continuous	T <sub>A</sub> = 25 °C	(Note 1a)	5.4	Α
	-Pulsed			48	
E <sub>AS</sub>	Single Pulse Avalanche Energy		(Note 3)	121	mJ
D	Power Dissipation	T <sub>C</sub> = 25 °C		54	W
P <sub>D</sub>	Power Dissipation	T <sub>A</sub> = 25 °C	(Note 1a)	2.3	VV
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature Range			-55 to +150	°C

### **Thermal Characteristics**

$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case	(Note 1)	2.3	°C/W
R <sub>0.1A</sub>	Thermal Resistance, Junction to Ambient	(Note 1a)	53	0/11

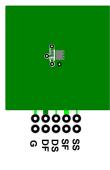
### Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMC86260	FDMC86260	Power33	13 "	12 mm	3000 units

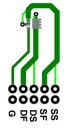
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Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chara	cteristics					
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	$I_{D} = 250 \ \mu A, V_{GS} = 0 \ V$	150			V
$\Delta BV_{DSS}$ $\Delta T_J$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		110		mV/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 120 V, V <sub>GS</sub> = 0 V			1	μA
I <sub>GSS</sub>	Gate to Source Leakage Current	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$			±100	nA
On Chara	cteristics					
V <sub>GS(th)</sub>	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 250 \ \mu A$	2	2.7	4	V
$\Delta V_{GS(th)}$ $\Delta T_{I}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		-9		mV/°C
Ū		$V_{GS} = 10 \text{ V}, I_{D} = 5.4 \text{ A}$		27	34	mΩ
r <sub>DS(on)</sub>	Static Drain to Source On Resistance	$V_{GS} = 6 V, I_D = 4.8 A$		31	44	
- (- )		V <sub>GS</sub> = 10 V, I <sub>D</sub> = 5.4 A, T <sub>J</sub> = 125 °C		55	69	
9 <sub>FS</sub>	Forward Transconductance	$V_{DD} = 10 \text{ V}, \ \text{I}_{D} = 5.4 \text{ A}$		19		S
Dynamic	Characteristics					
C <sub>iss</sub>	Input Capacitance			1000	1330	pF
C <sub>oss</sub>	Output Capacitance	─ V <sub>DS</sub> = 75 V, V <sub>GS</sub> = 0 V, f = 1 MHz		105	140	pF
C <sub>rss</sub>	Reverse Transfer Capacitance			4.8	10	pF
Rg	Gate Resistance		0.1	0.6	1.8	Ω
Switching	g Characteristics					
t <sub>d(on)</sub>	Turn-On Delay Time			9.5	19	ns
t <sub>r</sub>	Rise Time	V <sub>DD</sub> = 75 V, I <sub>D</sub> = 5.4 A,		2	10	ns
t <sub>d(off)</sub>	Turn-Off Delay Time	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$		17	30	ns
t <sub>f</sub>	Fall Time			3.3	10	ns
Q <sub>g(TOT)</sub>	Total Gate Charge	V <sub>GS</sub> = 0 V to 10 V		15	21	nC
Q <sub>g(TOT)</sub>	Total Gate Charge	$V_{GS} = 0 V \text{ to } 6 V$ $V_{DD} = 75 V$ ,		9.7	14	nC
Q <sub>gs</sub>	Total Gate Charge	I <sub>D</sub> = 5.4 A		4.0		nC
Q <sub>gd</sub>	Gate to Drain "Miller" Charge			3.1		nC
Drain-So	urce Diode Characteristics					
V <sub>SD</sub>	Source to Drain Diodo, Ecoward Veltage	$V_{GS} = 0 V, I_{S} = 5.4 A$ (Note 2)		0.77	1.3	V
* SD	Source to Drain Diode Forward Voltage	V <sub>GS</sub> = 0 V, I <sub>S</sub> = 1.9 A (Note 2)		0.72	1.2	V
t <sub>rr</sub>	Reverse Recovery Time	$I_{-} = 5.4 \text{ A} \cdot \text{di/dt} = 100 \text{ A/}\text{us}$		64	102	ns
Q <sub>rr</sub>	Reverse Recovery Charge	— I <sub>F</sub> = 5.4 A, di/dt = 100 A/μs		85	137	nC



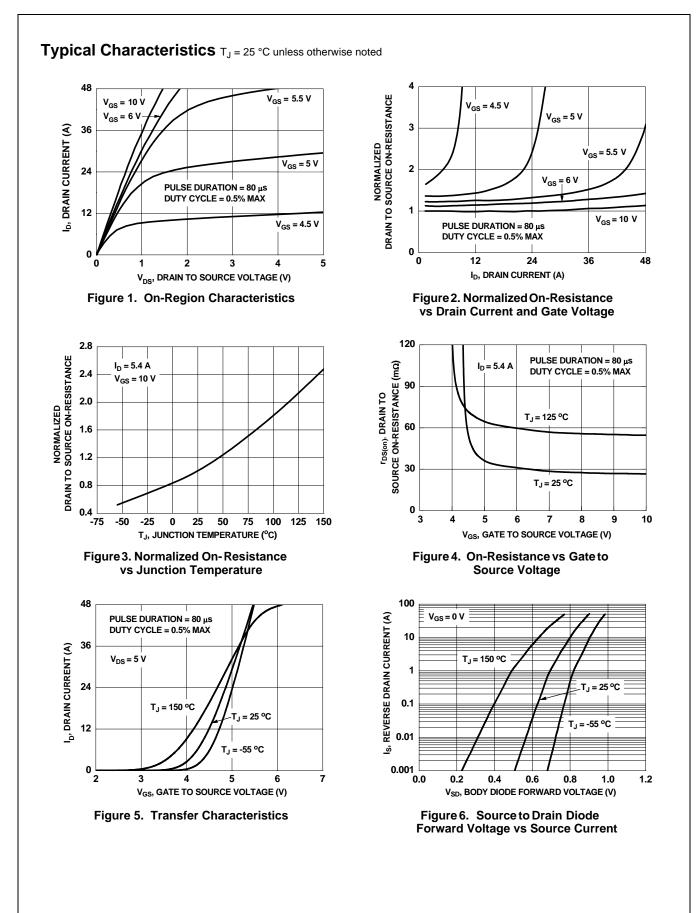
a. 53 °C/W when mounted on a 1 in<sup>2</sup> pad of 2 oz copper



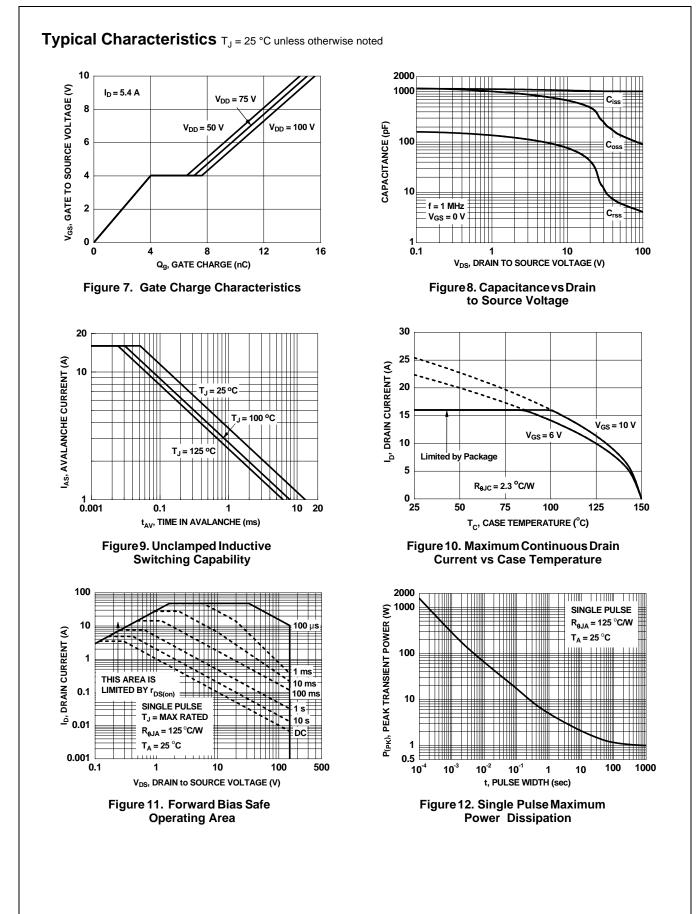
b. 125 °C/W when mounted on a minimum pad of 2 oz copper

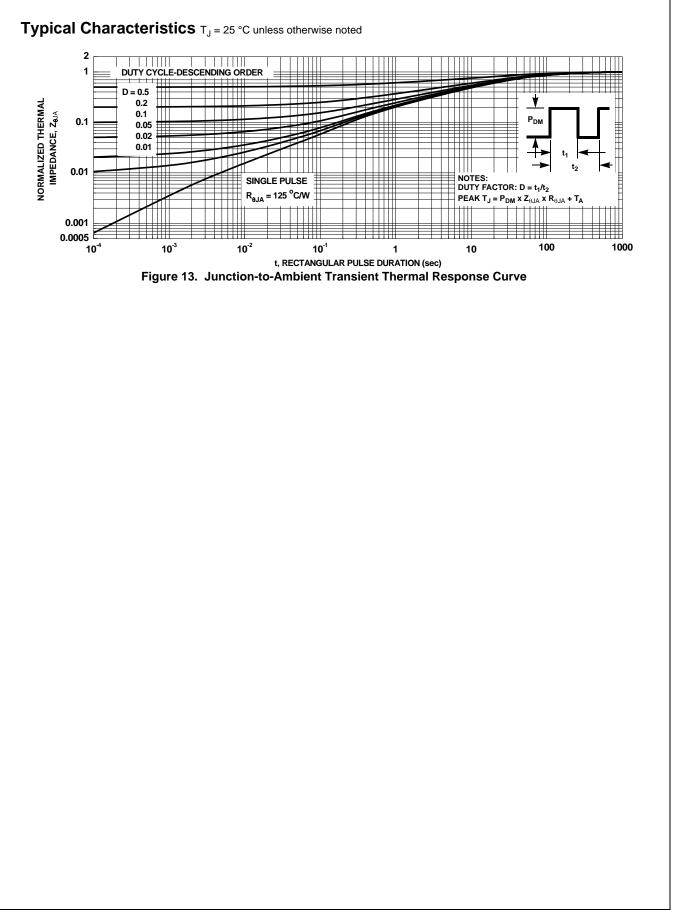
2. Pulse Test: Pulse Width < 300  $\mu \text{s},$  Duty cycle < 2.0%.

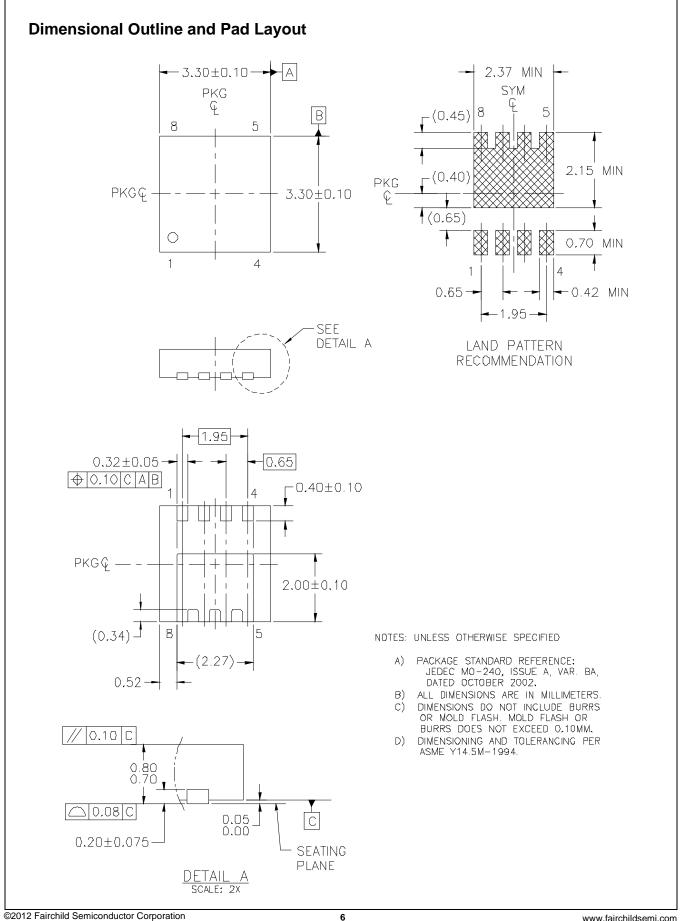
3. E<sub>AS</sub> of 121 mJ is based on starting T<sub>J</sub> = 25 °C, L = 3 mH, I<sub>AS</sub> = 9 A, V<sub>DD</sub> = 150 V, V<sub>GS</sub> = 10 V. 100% test at L = 0.1 mH, I<sub>AS</sub> = 22 A.











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